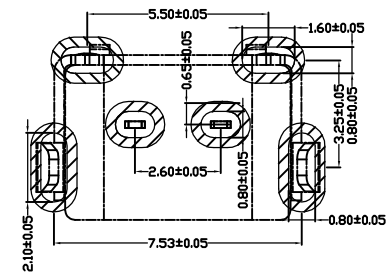
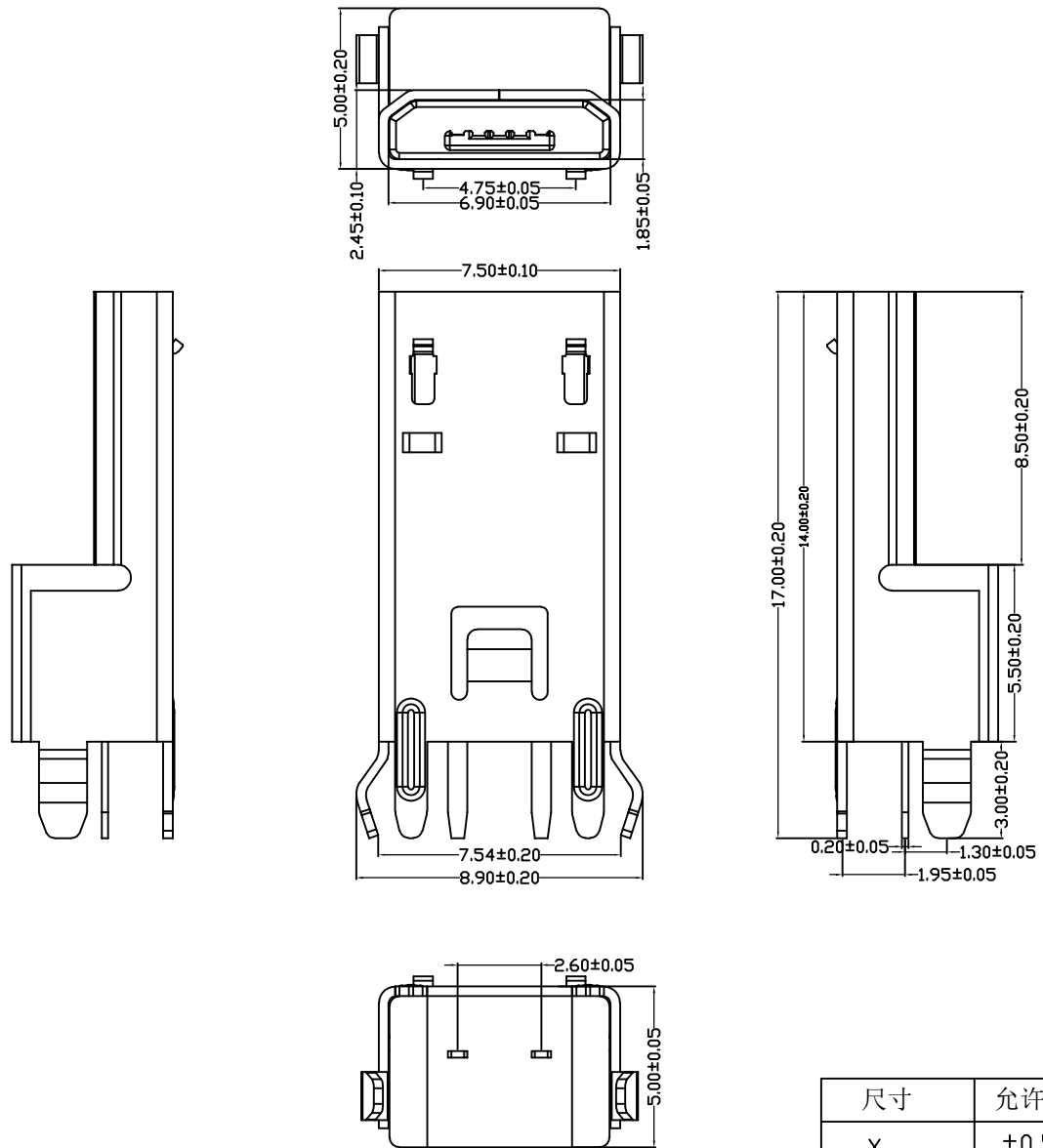


修改序号	修改说明	签名	日期
A/0			



RECOMMENDED PCB LAYOUT

Note:

1. Material:
 - 1.1 Housing: High temperature thermoplastic with g.f, UL94v-0
 - 1.2 Contact: copper alloy, t=0.20mm
 - 1.3 Shell: SPCC t=0.3mm or SUS t=0.25,
2. Specification:
 - 2.1 Current rating: 1A Max
 - 2.2 Dielectric withstanding woltage: 100V(AC) for 1 min.
 - 2.3 Contact resistance: 40mΩ Max.
 - 2.4 Insulation resistance: 100MΩ min.
 - 2.5 Tatal mating force: 3.57 Kgf Max.
 - 2.6 Total unmating force: 1.0 Kgf Min. 0.81~2.05 Kgf Min. after 3000 insertion/extraction cycles
 - 2.7 Temperature range: -30° C~80° C

深圳市创勤科技有限公司 Shenzhen Chuangqin Technology Co., Ltd.			
图纸类型		图纸名称:	
产品工程图		MICRO USB 2P母座180° DIP长体L=14MM弯角有柱	
设计	LIN YUN	2017.05.12	产品料号 CQ028-MFLC21402020
审核			视图 版号: A/0

尺寸	允许公差
.X	±0.50
.X	±0.20
.XX	±0.10
.XXX	±0.03
角度	±1.00°